~~【~~[CLAIMS~~】~~]

~~【~~[Claim 1~~】~~]

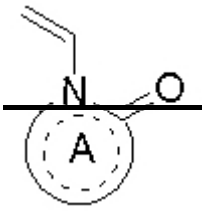
An adhesive resin composition comprising a dicyclopentadiene-based hydrogenated resin and a thermoplastic resin,

wherein the dicyclopentadiene-based hydrogenated resin is prepared by hydrogenating a dicyclopentadiene-based resin prepared by copolymerizing a monomer composition including a dicyclopentadiene-based monomer and a vinylamide-based monomer~~.~~, and

~~【Claim 2】~~

~~The dicyclopentadiene-based resin of claim 1, wherein the vinylamide-based monomer satisfies a following Chemical Formula 1:~~

~~[Chemical Formula 1]~~



~~wherein~~

~~A is a saturated or unsaturated cyclic hydrocarbon.~~

~~【Claim 3】~~

~~The dicyclopentadiene-based resin of claim~~

~~1, wherein the dicyclopentadiene-based monomer and the vinylamide-based monomer are included at a weight ratio of 99:1 to 50:50.~~

~~【Claim 4】~~

~~A dicyclopentadiene-based hydrogenated resin prepared by hydrogenating the dicyclopentadiene-based resin of claim 1.~~

~~【Claim 5】~~

~~An~~ adhesive resin composition ~~comprising the dicyclopentadiene-based hydrogenated resin of claim 4 and a thermoplastic resin~~has a mixed methylcyclohexane aniline cloud point of 60°C or lower and a diacetone alcohol cloud point of 60°C or lower.

~~【~~[Claim ~~6】~~ 2]

The adhesive resin composition of claim ~~5~~1, further comprising an oil.

~~【~~[Claim ~~7】~~ 3]

The adhesive resin composition of claim ~~6~~2, wherein the oil includes any one or two or more selected from the group consisting of paraffin-based oils, naphthene-based oils, and aromatic-based oils.

~~【~~[Claim ~~8】~~ 4]

The adhesive resin composition of claim ~~5~~1,

wherein 50 to 90 wt% of the dicyclopentadiene-based hydrogenated resin and 10 to 50 wt% of the thermoplastic resin are included, based on a total weight of the adhesive resin composition.

~~【~~[Claim ~~9】~~ 5]

The adhesive resin composition of claim ~~6~~2, wherein 1 to 60 parts by weight of the oil is included, based on 100 parts by weight of the dicyclopentadiene-based hydrogenated resin and the thermoplastic resin.

~~【~~[Claim ~~10】~~ 6]

The adhesive resin composition of claim ~~5~~1, wherein the ~~adhesive resin composition has~~dicyclopentadiene-based monomer and the vinylamide-based monomer are included at a ~~mixed methylcyclohexane aniline cloud point~~weight ratio of ~~60°C or lower and a diacetone alcohol cloud point of 60°C or lower.~~

99:1 to 50:50.